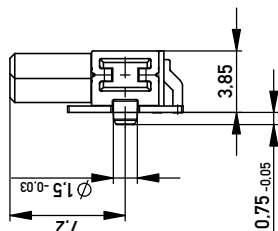
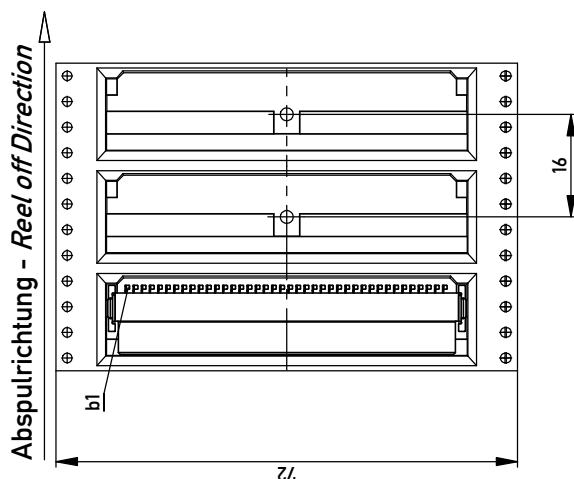
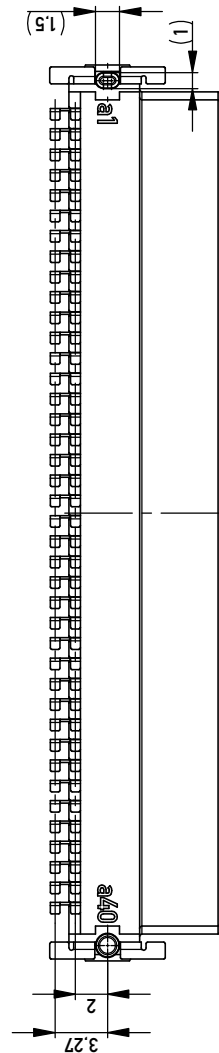
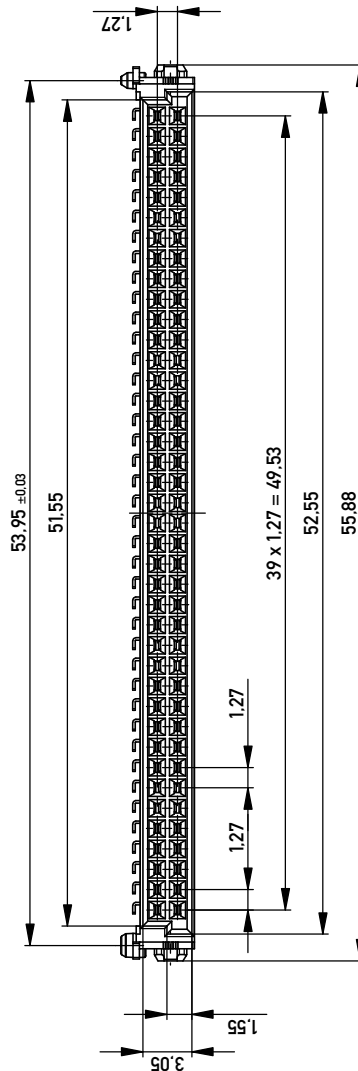
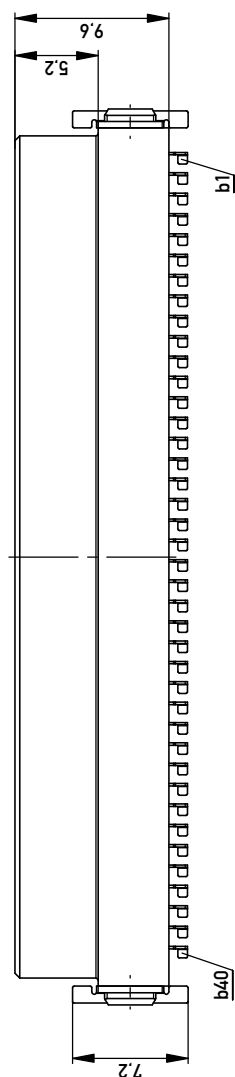
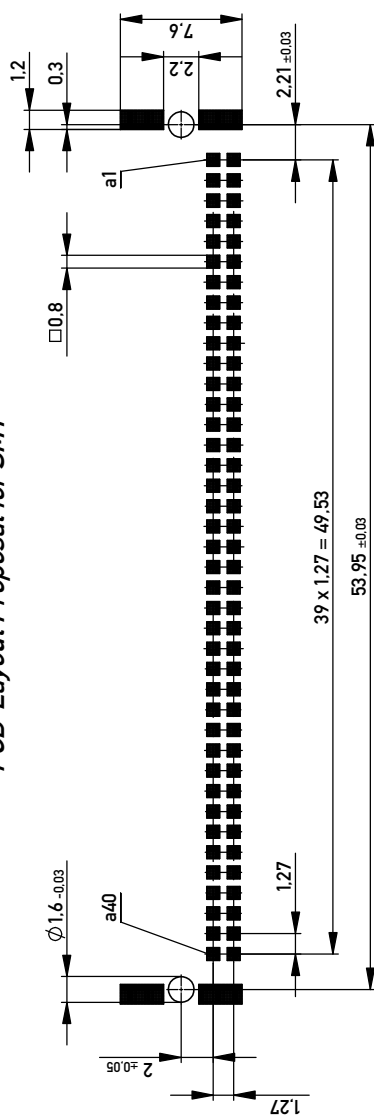
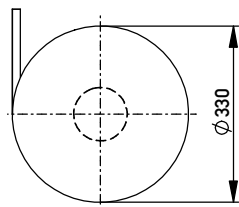


Leiterplatten-Layout Vorschlag für SMT

Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 560 Stück
Packaging unit: 560 pcs



Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse $\leq 0,1\text{ mm}$
Coplanarity Area of Termination $\leq 0,1\text{ mm}$

BA7-03 - Standard Bauhöhe		BA7-03 - standard assembly height	
Scale		3:1	
Tolerances		 All Dimensions in mm	
Information: ALL rights reserved. Only for Information. To ensure that this is the latest version of this drawing, please contact one of the ERNI companies before using.		Designation Federl. SMC-Q 80-SMD-BA7-03 <i>Female SMC-Q 80-SMD-type7-03</i>	
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